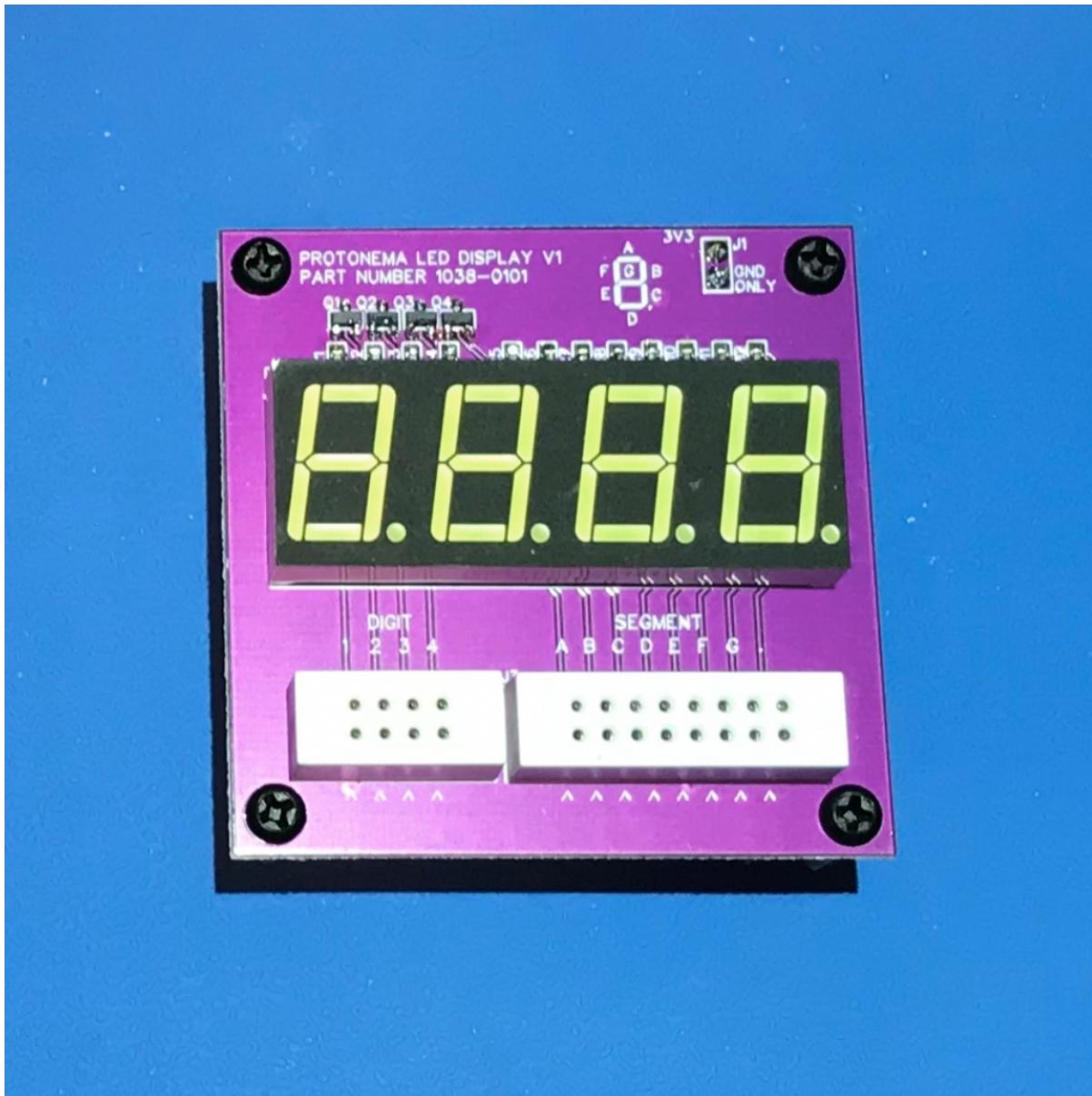


ASSEMBLY INSTRUCTIONS

1038A LED Display Stamp



5 Document control number: 1038-8010

6 Document date: 2022-12-24

7 Document revision: 1.0.0

8 ABSTRACT: This document provides instructions on how to assemble and test a 1038A LED display stamp. A
9 complete bill of materials is included as an annex.

10 Suggestions and corrections should be directed to <http://www.github.com/dslik/protonema/issues>

11 Serial number: Assembly date: Assembled by:

12 USAGE

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21 Source location: <https://github.com/dslik/protonema/tree/main/stamps/1038A>

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51 Revision history

Table 1: Document Revisions

Version	Date	Change	Approver
1.0.0-draft.1	2022-11-26	Initial draft	D. Slik
1.0.0	2022-12-24	Added missing images	D. Slik

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194

Part I

195

1038A assembly instructions

196 **Section 1**

197 **Overview**

- 198 This document describes the materials, processes, outcomes and verifications required to successfully assemble
199 and test a 1038A LED display stamp, a sub-component of the Protonema electronics prototyping and learning
200 system.
- 201 A first-time reader should carefully review section 2 - prerequisites, and section 3 - preparation before beginning
202 the assembly process.
- 203 This document serves both as instructions and as a record of the assembly of the product. When you finish each
204 step in this document, sign your name (or apply your stamp) in the "Signature/Stamp" box on the right to provide a
205 record of completion.
- 206 When things go wrong, this document provides guidance for common issues that have been encountered in the
207 past. When this document does not provide guidance, please contact your quality management representative,
208 who will help you fill out an exception report. These reports help improve process quality and product quality, and
209 these reports are incorporated into future revisions of this document.
- 210 Always remember: If you are unable to successfully complete these instructions, that means the processes sup-
211 porting you (including this document) have failed you. Our processes are built for your success, and by improving
212 our processes, we help everyone succeed.

²¹³ Section 2

²¹⁴ Prerequisites

²¹⁵ 2.1 Required safety training

- ²¹⁶ The following safety training units must be completed before assembling this product.
- ²¹⁷ By signing (or applying your stamp) on the right, you indicate that you have completed the following training:

Table 2: Safety training

Item #	Description	Signature/Stamp
1	0102-0100 - Safety reporting policies and procedures training Key topics: Understanding policies and procedures around how to identify, contain and report a safety-related issue in the workplace, including damaged or malfunctioning equipment, leaks, spills, and other occupational hazards.	 Stamp or sign here
2	0102-0101 - Material safety data sheets training Key topics: Understanding how to read material safety data sheets (MSDS) for materials you will be handling during product assembly, how they can affect your health and the health of the environment, how to safely handle and dispose of them, and what to do if there is a spill or accidental exposure.	 Stamp or sign here
3	0102-0102 - Solder handling and disposal policies and procedures training Key topics: Understanding policies and procedures related to handling solder and solder paste, stencil cleaning, and solder disposal.	 Stamp or sign here
4	0102-0105 - Electro-static discharge controls policies and procedures training Key topics: Understanding policies and procedures related to protecting equipment and components from electro-static discharge, including clothing, protective equipment, material handling and labelling.	 Stamp or sign here

2.2 Required skills training

- ²¹⁸ The following skills training units must be completed before assembling this product.
²²⁰ By signing (or applying your stamp) on the right, you indicate that you have completed the following training:

Table 3: Skills training

Item #	Description	Signature/Stamp
1	0103-0202 - ANSI/ESD S20.20 Electro-static discharge controls Key topics: Understanding of ESD safety, the ESD control program, equipment and personnel grounding, EPAs, packaging and marking.	Stamp or sign here
2	0103-0203 - General components handling Key topics: Understanding of safe component handling, including reeled components, components in JEDEC trays, and loose components. Includes avoiding contamination, moisture control, and component inventory management.	Stamp or sign here
3	0103-0414 - 5040-XTS reflow station Key topics: Safe and effective use of the 5040-XTS reflow station, including use of the pre-heater, the hot air system, and the soldering iron. Covers inspection and verification, cleaning, preferred settings and best practice techniques.	Stamp or sign here
4	0103-0301 - IPC-A-610G - Acceptability of electronic assemblies Key topics: Covers visual acceptability requirements for electronic assemblies, including handling considerations, hardware installation, component placement, soldering, terminal connections, wiring, marking and cleanliness.	Stamp or sign here
5	0103-0302 - IPC-J-STD-001F - Soldered electrical connections Key topics: Covers soldering materials, general soldering and assembly requirements, wire and terminal connections, through-hole mounting, surface mounting of components, cleaning process requirements, PCB requirements, coatings and product assurance.	Stamp or sign here

Section 3

Preparation

3.1 Workspace

- Before starting assembly, check out an assembly desk for a minimum of one hour. Units are assembled in batches of four, with each batch taking 20 minutes.

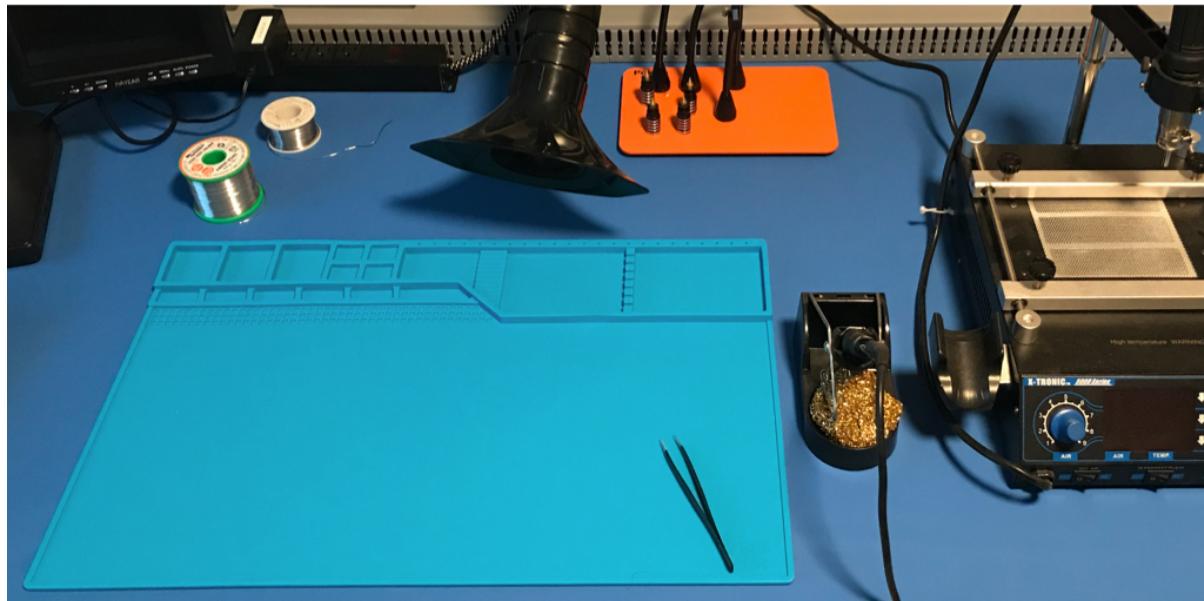


Fig. 1: Assembly Desk

Table 4: Prepare workspace

Step	Description	Signature/Stamp
3.1.1	Verify that the workspace has a clean assembly mat and anti-static mat, and that the cleaning record has been signed since last use.	Stamp or sign here
3.1.2	Verify that the HEPA fume extractor turns on, and you can feel air suction from the nozzle.	Stamp or sign here

continues on next page

Table 4 – continued from previous page

Step	Description	Signature/Stamp
3.1.3	Verify that the 5040-XTS rework station soldering iron tip is not worn down. If it is worn down, obtain a new 900M-T-I tip from the stores department.	Stamp or sign here
3.1.4	Verify that the heating surface of the MHP30 hot plate is clean.	Stamp or sign here

226 3.2 Project consumables

227 Obtain each of the below consumable items from the stores department:

Table 5: Assembly consumables

Item #	Description	Signature/Stamp
3.2.1	 <p>Fig. 2: 1 pair ESD gloves If you prefer to use your own pair of ESD gloves, make sure they are tested before use.</p>	Stamp or sign here
3.2.2	 <p>Fig. 3: 1 spool MG Chemicals 4900 Lead Free No-Clean Wire Solder Sn96.2Ag2.8Cu0.4 (96.2/2.8/0.4) 20 AWG</p>	Stamp or sign here

228 3.3 Project tools

- 229 Obtain a tools container labelled “1XXX Assembly Tools” from the 1XXX section of the stores supply shelf. At your assembly desk, use [Table 6](#) to verify that all the required tools are present.
- 230 If any required tools are missing, return all tools and the tools container to the stores department, and obtain another tools container.



Fig. 4: Tools Container

- 233 Remove each of the following tools from the tools container, and place them on the anti-static mat of the assembly desk:

Table 6: Assembly tools

Item #	Description	Signature/Stamp
3.3.1		Stamp or sign here

Fig. 5: Hozan F-23 components tray

continues on next page

Table 6 – continued from previous page

Item #	Description	Signature/Stamp
3.3.2	 Fig. 6: ESD tweezers	 Stamp or sign here
3.3.3	 Fig. 7: 3mm Phillips adjustable torque screwdriver	 Stamp or sign here
3.3.4	 Fig. 8: Fine-tipped Sharpie marker	 Stamp or sign here

continues on next page

Table 6 – continued from previous page

Item #	Description	Signature/Stamp
3.3.5	 Fig. 9: Scissors	Stamp or sign here

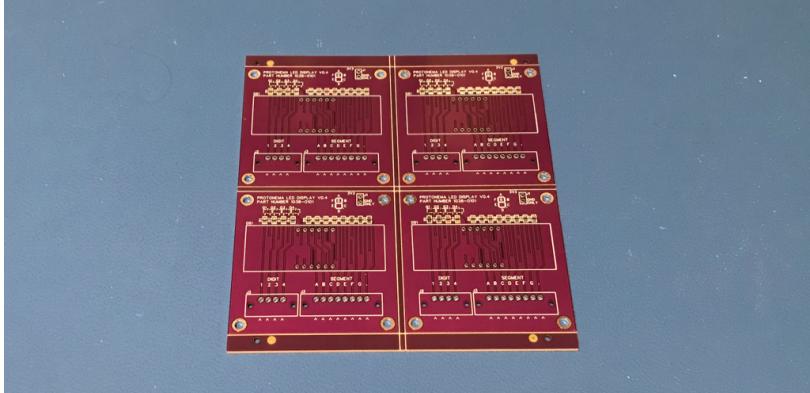
235 3.4 Parts preparation

236 3.4.1 PCBs and PCBAs

237 NOTICE: All PCBs and PCBAs must be handled with gloves to prevent marking with skin oils.

238 NOTICE: PCBs are removed from manufacturer packaging only when needed.

Table 7: PCBs and PCBAs

Item #	Description	Signature/Stamp
3.4.1.1	No marking required  Fig. 10: 1x 1038-0101 v1.0 - LED Display Stamp PCB	Stamp or sign here

239 3.4.2 Reel cuttings

- 240 All reels are stored in the bin labelled "1XXX Reels" on the shelf labelled "1XXX Components". As this is a manually
 241 assembled product (no automated pick-and-place), tape should be cut off as needed for the number of units being
 242 assembled, and placed in the assembly tray.

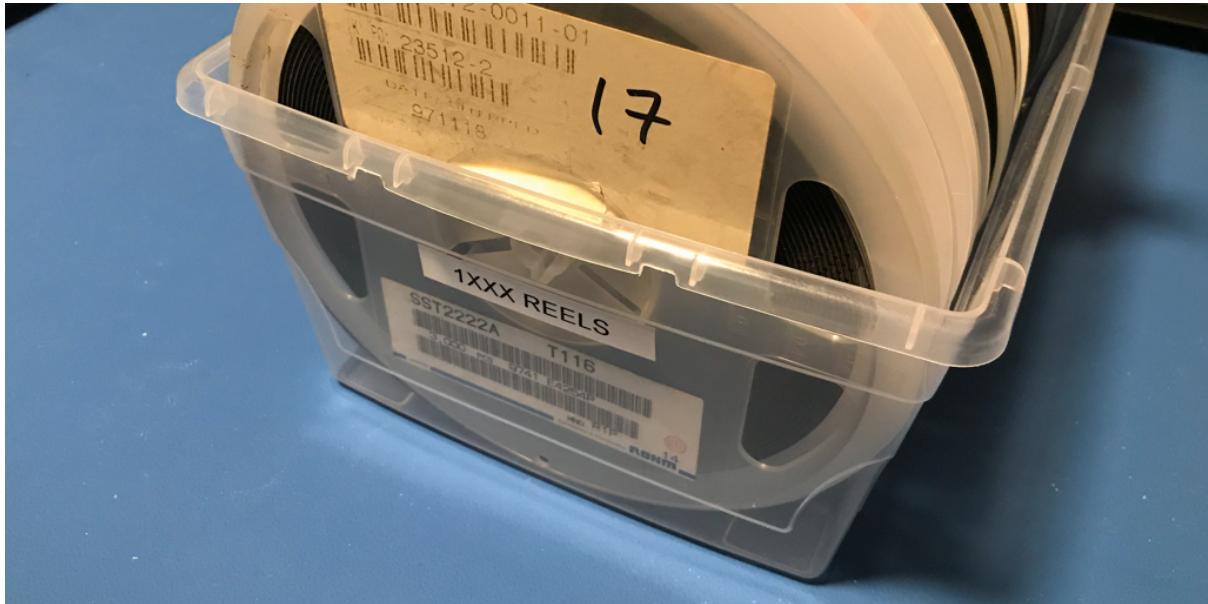


Fig. 11: Reels Container

- 243 Cut off the indicated number of parts (multiplied by the number of units to be assembled), and mark them with the
 244 value:

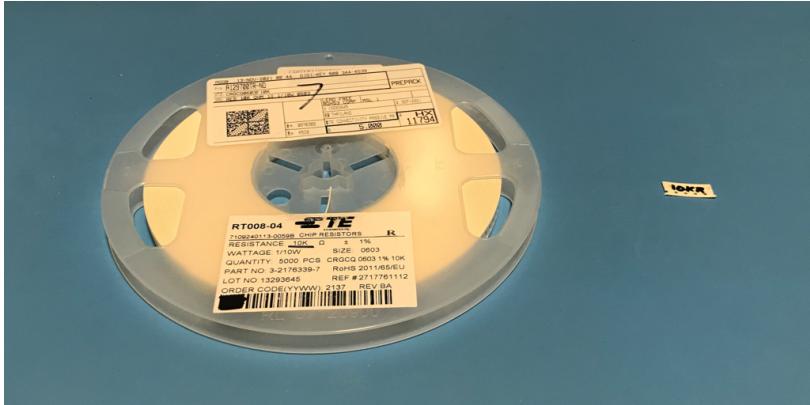
Table 8: Assembly reels

Reel #	Description	Signature/Stamp
1	Mark with "649R" 	Stamp or sign here

Fig. 12: 8x 649 Ohm 0603 resistors

continues on next page

Table 8 – continued from previous page

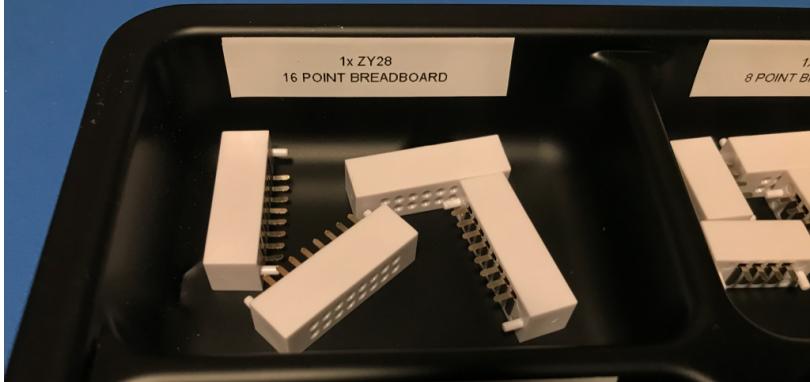
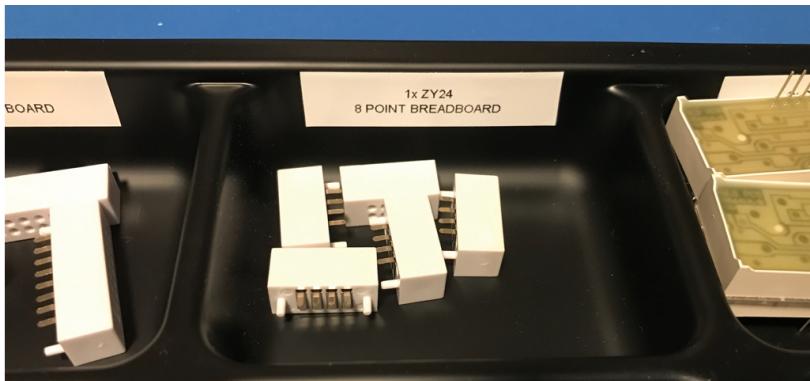
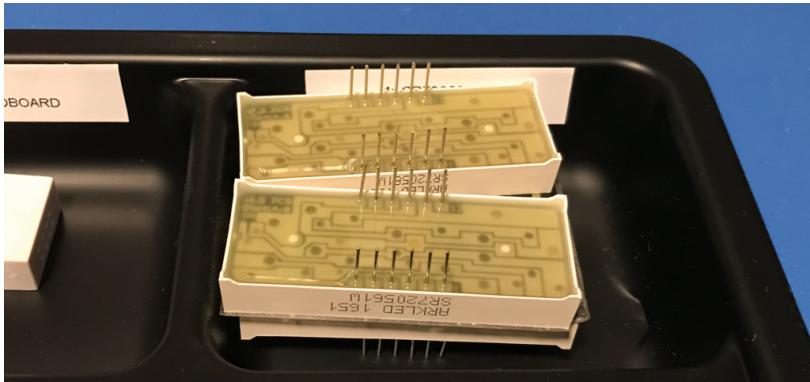
Reel #	Description	Signature/Stamp
7	Mark with "10KR" 	Stamp or sign here
17	No marking required 	Stamp or sign here

245 Be sure to return the 1XXX Reels bin as soon as you have finished cutting off the required parts.

246 3.4.3 Loose components

247 All loose components are stored on the shelf labelled "1XXX Components". Take the components tray and obtain
 248 the following quantities of the following parts:

Table 9: Loose components

Item #	Description	Signature/Stamp
3.4.3.1	No marking required  Fig. 15: 1x ZY28 - 16 Point solderless breadboard	Stamp or sign here
3.4.3.2	No marking required  Fig. 16: 1x ZY24 - 8 Point solderless breadboard	Stamp or sign here
3.4.3.3	No marking required  Fig. 17: 1x SR720561W - Four digit white LED seven-segment display	Stamp or sign here

continues on next page

Table 9 – continued from previous page

Item #	Description	Signature/Stamp
3.4.3.4	No marking required  Fig. 18: 1x 0022284020 - 1x2 2.54mm Male Header	Stamp or sign here
3.4.3.5	No marking required  Fig. 19: 4x 5mm M3 Nylon Screws	Stamp or sign here
3.4.3.6	No marking required  Fig. 20: 4x M3 11mm+6 Black Nylon Standoffs	Stamp or sign here

continues on next page

Table 9 – continued from previous page

Item #	Description	Signature/Stamp
3.4.3.7	No marking required  Fig. 21: 4x M3 Black Nylon Nuts	Stamp or sign here

249 3.4.4 Packaging materials

- 250 All packaging materials are stored on the shelf labelled "1XXX Components". Take the packaging box and obtain
 251 the following quantities of the following materials:

Table 10: Packaging materials

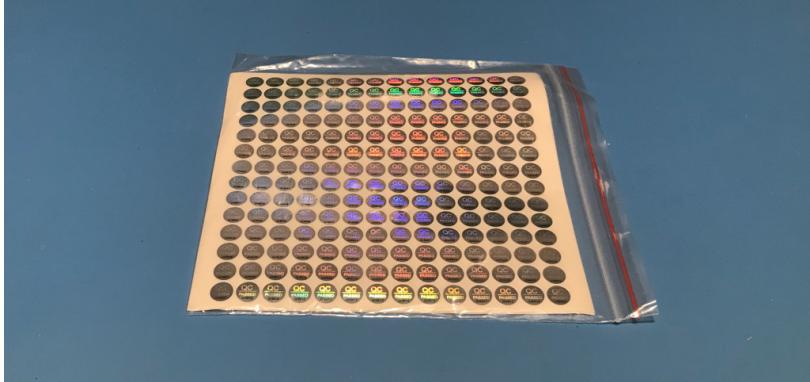
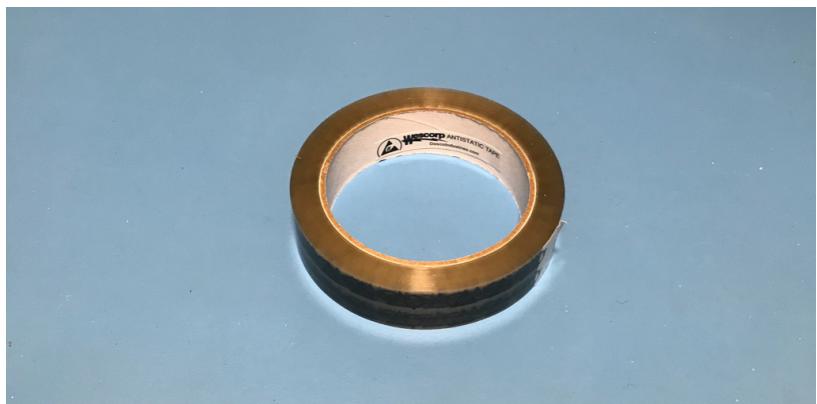
Item #	Description	Signature/Stamp
3.4.4.1	No marking required 	Stamp or sign here
3.4.4.2	No marking required 	Stamp or sign here
3.4.4.3	No marking required 	Stamp or sign here

Fig. 22: 1x QC Sticker

continues on next page

Table 10 – continued from previous page

Item #	Description	Signature/Stamp
3.4.4.4	<p>No marking required</p> 	<div style="text-align: center; border: 1px solid gray; border-radius: 50%; width: 100px; height: 100px; margin: auto;"> Stamp or sign here </div>
3.4.4.5	<p>No marking required</p> 	<div style="text-align: center; border: 1px solid gray; border-radius: 50%; width: 100px; height: 100px; margin: auto;"> Stamp or sign here </div>
3.4.4.6	<p>No marking required</p> 	<div style="text-align: center; border: 1px solid gray; border-radius: 50%; width: 100px; height: 100px; margin: auto;"> Stamp or sign here </div>

252 Section 4

253 Assembly

254 4.1 1038A assembly

255 This assembly step takes 5 minutes.

Table 11: 1038A assembly steps

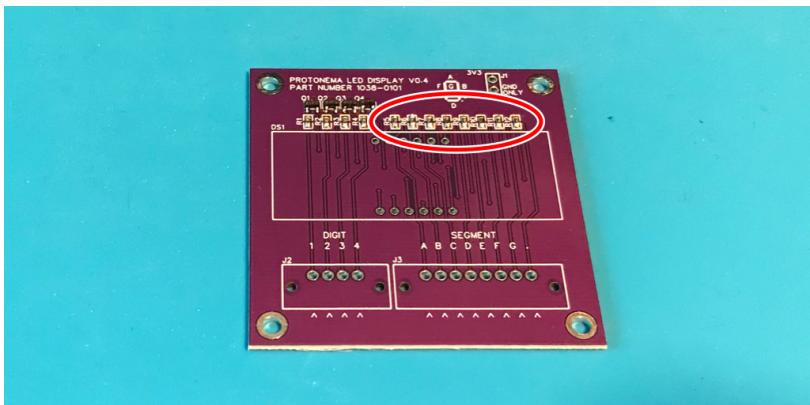
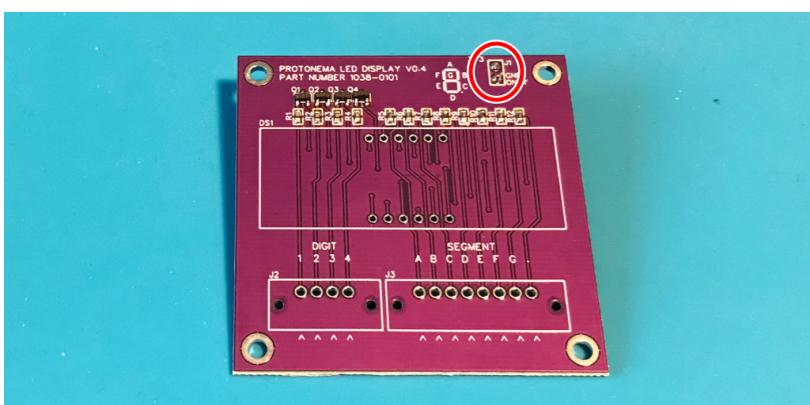
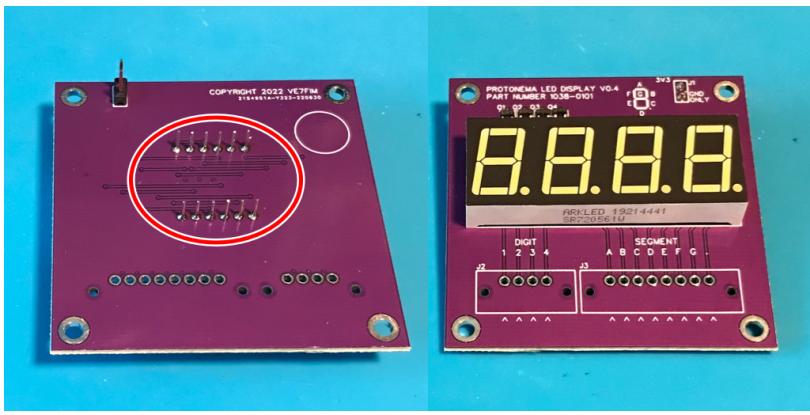
Step #	Description	Signature/Stamp
4.1	Solder Q1 through Q4 onto the 1038-0101 PCB.	 Stamp or sign here
4.2	Solder R1 through R4 onto the 1038-0101 PCB.	 Stamp or sign here

Fig. 28: 1038-0101 PCB with Q1-Q4 soldered on.

Fig. 29: 1038-0101 PCB with R1-R4 soldered on.

continues on next page

Table 11 – continued from previous page

Step #	Description	Signature/Stamp
4.3	Solder R5 through R12 onto the 1038-0101 PCB.	Stamp or sign here
		
	Fig. 30: 1038-0101 PCB with R5-R12 soldered on.	
4.4	Insert the 2 pin header into J1 from the rear of the board, flip the board, and solder one pin of the header on, flip the board again and sure it is 90 degrees to the board, then solder the remaining pin.	Stamp or sign here
		
	Fig. 31: 1038-0101 PCB with J1 soldered on.	
4.5	Insert the SR720561W display module with the dots facing down. Flip the board, and solder the display connectors, making sure that the display module pins are consistently at the top of the through holes.	Stamp or sign here
		
	Fig. 32: 1038-0101 PCB with the display module soldered on.	

continues on next page

Table 11 – continued from previous page

Step #	Description	Signature/Stamp
4.6	Insert the small breadboard module, then solder.	
4.7	Insert the large breadboard module, then solder.	
4.8	For each of the four corner holes, attach a nylon screw to a nylon post through the hole.	

Fig. 33: 1038-0101 PCB with the small breadboard module soldered on.

Fig. 34: 1038-0101 PCB with the small breadboard module soldered on.

Fig. 35: 1038-0101 PCB with four nylon posts attached.

²⁵⁶ Section 5

²⁵⁷ Test

²⁵⁸ 5.1 Visual inspection

²⁵⁹ This test process takes 2 minutes.

Table 12: 1038A visual inspection

Step #	Description	Signature/Stamp
1	Verify that there are no loose parts.	Stamp or sign here
2	Verify that there are no visible fingerprints.	Stamp or sign here

260 5.2 QC final check

261 This test process takes 2 minutes.

Table 13: 1038A QC final check

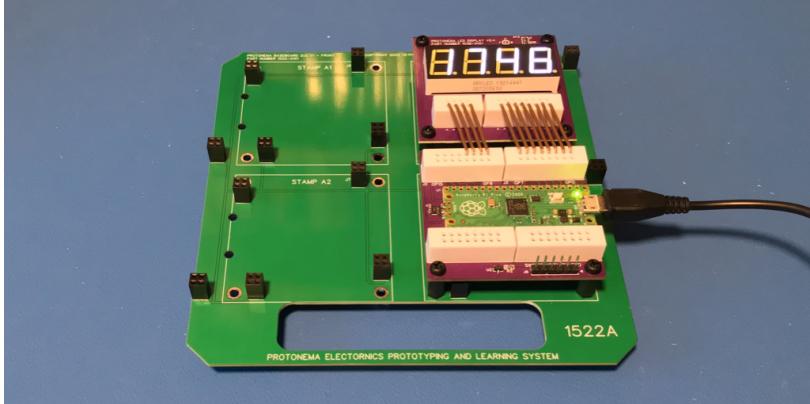
Step #	Description	Signature/Stamp
1	<p>Connect the 1038A to a baseboard and to a pre-programmed 1031A, as shown below. Connect power and verify that the digits count up. Wait to the count reaches 1,000 to verify all four digits are correctly wired.</p> <p>If test does not pass, write down the unexpected behaviour in the "Signature/Stamp" column on the right.</p> 	Stamp or sign here

Fig. 36: Powered 1038-0101 PCB driven by a 1031A.

262 5.3 QC PASS

263 Only perform these steps if all QC checks have passed.

264 This test process takes 1 minutes.

Table 14: 1038A QC approval

Step #	Description	Signature/Stamp
1	Using the tweezers, affix QC Passed sticker in location shown below, then write down the serial number from the QC sticker below the "Signature/Stamp" in the column to the right. 	
2	Take two photographs, one of the front of the 1038A, and one of the back of the 1038A.	

265 5.4 QC FAIL

- 266 Only perform these steps if any QC check have failed.
 267 This test process takes 2 minutes.

Table 15: 1038A QC fail

Step #	Description	Signature/Stamp
1	Place the 1038A module in the anti-static bag. 	Stamp or sign here
2	Take an A4 plastic bag, and place the 1038A, along with this document, in the "QC Fail" bin 	Stamp or sign here

Fig. 38: 1038A in anti-static bag.

Stamp or sign here

Stamp or sign here

268

Section 6

269

Packaging

270

6.1 1038A packing

271

This packaging process takes 3 minutes.

Table 16: 1038A packaging

Step #	Description	Signature/Stamp
6.1.1	Place the 1038A module in the anti-static bag. 	
6.1.2	Place four nylon nuts in a small anti-static bag, and add the bottom of the bag to the bag the 1038A module is in. 	

Fig. 40: 1038A in anti-static bag.

Fig. 41: Anti-static bag with nylon nuts in the small anti-static bag.

continues on next page

Table 16 – continued from previous page

Step #	Description	Signature/Stamp
6.1.3	Seal the anti-static bag with a 1038A sticker.	Stamp or sign here
		
	Fig. 42: 1028A in anti-static bag with sticker.	
6.1.4	Using the Sharpie pen, Write down the serial number of the 1038A on the sticker, at the end of the line listing the 1038A.	Stamp or sign here
		
	Fig. 43: Example photographs of the sealed bag with the serial number written on the sticker	
6.1.5	Place 1038A bag in the box on top of the bottom foam padding.	Stamp or sign here
		
	Fig. 44: 1038A in box.	
6.1.6	Take a photograph of the 1038A in the box.	Stamp or sign here

continues on next page

Table 16 – continued from previous page

Step #	Description	Signature/Stamp
6.1.7	Using the ESD tape, secure the lid of the box.	Stamp or sign here
		
	Fig. 45: 1038A in box, sealed with ESD tape.	
6.1.8	Affix a 1038A sticker to the lid of the box.	Stamp or sign here
		
	Fig. 46: 1038A in box with sticker.	
6.1.9	Using the Sharpie pen, Write down the serial number of the 1038A on the sticker, at the end of the line listing the 1038A.	Stamp or sign here
		
	Fig. 47: 1038A in box with sticker with serial number.	
6.1.10	Take a photograph of the sealed 1038A box.	Stamp or sign here

²⁷² Section 7

²⁷³ Clean-up

²⁷⁴ 7.1 Consumables

²⁷⁵ This packaging process takes 5 minutes.

Table 17: Consumables cleanup

Step #	Description	Signature/Stamp
1	If the ESD gloves have contacted solder paste, or are soiled, they shall be disposed of in the standard waste bin.	
2	If there is unused solder wire on the spool, it shall be returned to stores.	
3	Loose component packaging shall be disposed of in the standard waste bin.	

²⁷⁶ 7.2 Tools

²⁷⁷ This cleanup process takes 5 minutes.

Table 18: Tools cleanup

Step #	Description	Signature/Stamp
1	All tools shall be returned to the assembly tools container, and returned to the stores supply shelf. If any tools are damaged or worn, return the container to stores, and let the manager know which tool is damaged or worn.	

continues on next page

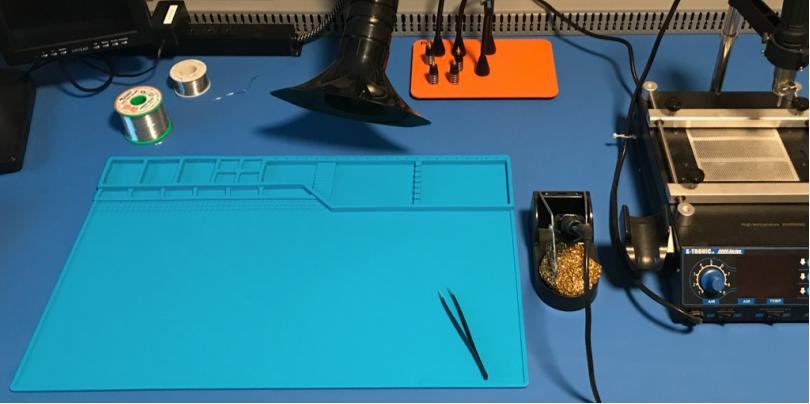
Table 18 – continued from previous page

Step #	Description	Signature/Stamp
2	Remove this document from the springback binder.	 Stamp or sign here
3	Print a new copy of this document, and insert it into the springback binder that this document was originally in.	 Stamp or sign here
4	Return the springback binder with the newly printed document to the 1038A section of the store supply shelf.	 Stamp or sign here

278 7.3 Workspace

279 This packaging process takes 5 minutes.

Table 19: Workspace cleanup

Step #	Description	Signature/Stamp
1	Make sure that the workspace is clean and as it was when you started the assembly.  Fig. 48: Clean assembly workstation	Stamp or sign here

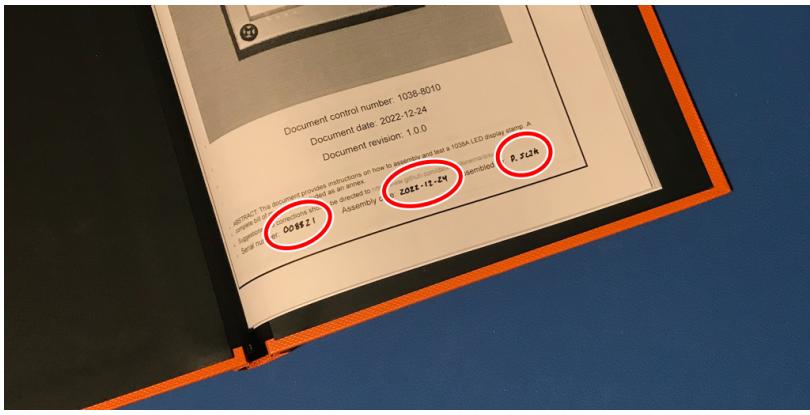
280 Section 8

281 Record keeping

282 8.1 1038A record keeping

283 This packaging process takes 5 minutes.

Table 20: 1038A record keeping

Step #	Description	Signature/Stamp
1	<p>Write the serial number, the date, and your first and last name in large print on the bottom of the front cover of this document.</p> 	Stamp or sign here
2	Create a new folder under the 1038A folder, named with the serial number.	Stamp or sign here
3	Copy all photos taken during the assembly process into the newly created folder in step #2.	Stamp or sign here
4	Remove this document from the binding clamps, scan the document, and save the scanned PDF into the newly created folder in step #2, with the name "1038A-SNAAAAAA.pdf", where AAAAAA is replaced with the serial number.	Stamp or sign here

continues on next page

Table 20 – continued from previous page

Step #	Description	Signature/Stamp
5	Three-hole punch the document, then file it at the end of the current month's assembly records binder.	 Stamp or sign here
6	Add an entry to the assembly records binder, "<Date> - 1038A - SN# AAAAAAA - <Your Name>", where <Date> is replaced with today's date in ISO-8601 YYYY-MM-DD, where AAAAAAA is replaced with the serial number of the 1038A, and where <Your Name> is replaced with your first and last name.	 Stamp or sign here

284 **Section 9**

285 **Process improvement**

286 **9.1 Feedback**

287 Please submit an issue to the [Protonema Issue Repository](http://www.github.com/dslik/protonema/issues) (<http://www.github.com/dslik/protonema/issues>) if you
288 encounter any of the below situations:

- 289 • Error in this document
- 290 • Unclear directions
- 291 • Suggested process improvements
- 292 • Results of QC failure investigations
- 293 • Tool change suggestions

294 Qualtiy processes and documentation is a team effort. This document would not exist without the participation and
295 contributions of the entire assebly team.

296 Thank you for reading this assembly instructions document.

297 End of document.

298

Part II

299

1038A Annexes

300 Section 10

301 Printed Circuit Boards

302 10.1 1038-0101 PCB

Table 21: 1038-0101 PCB

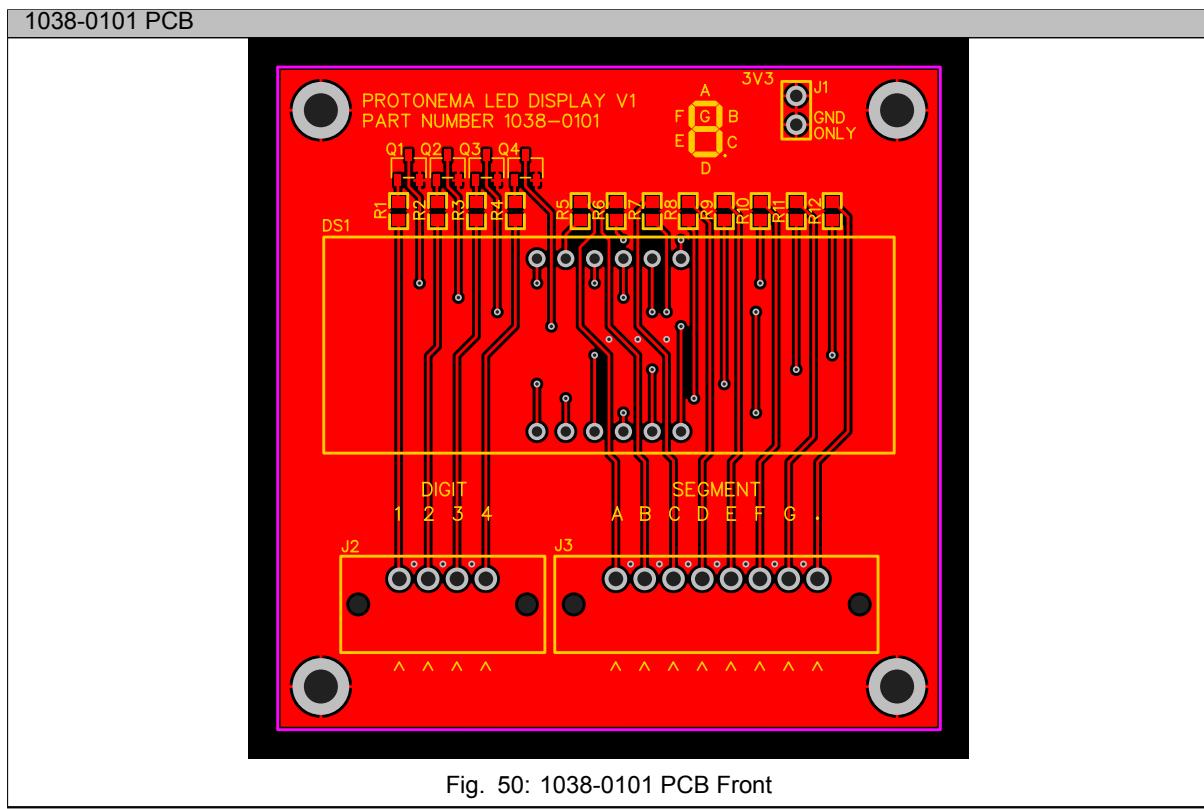
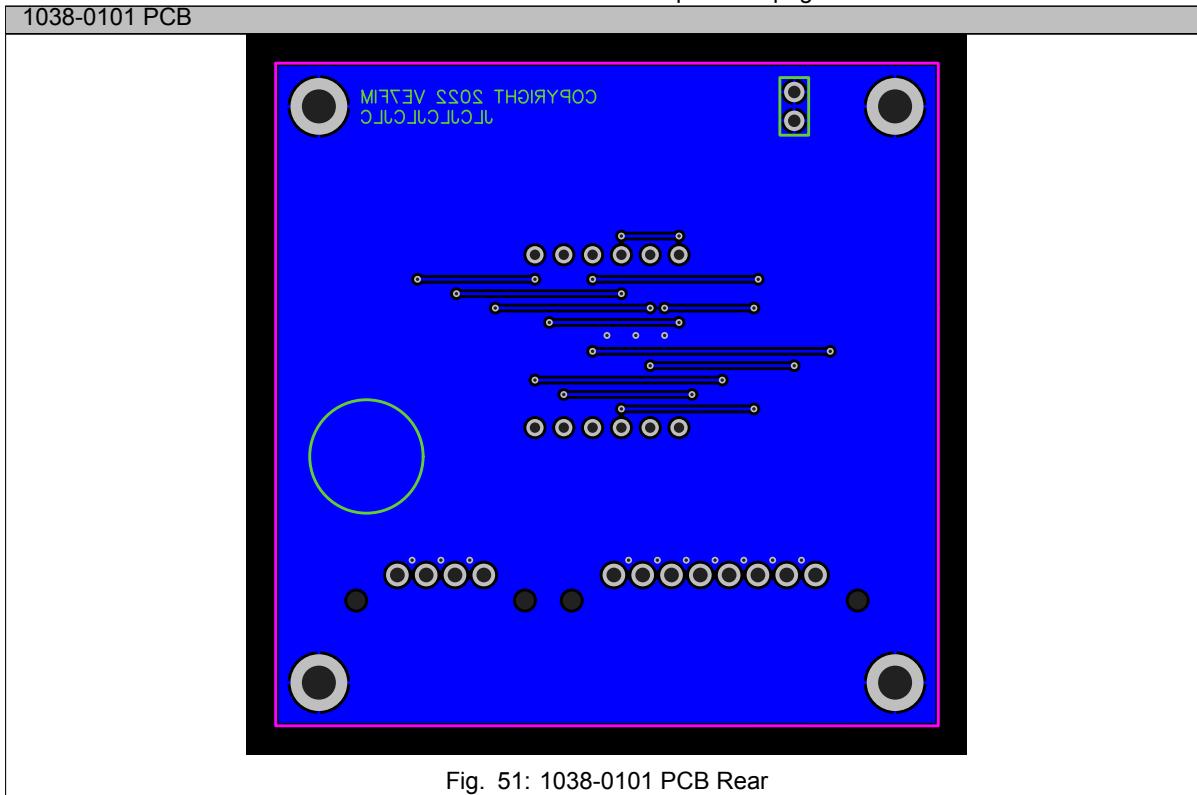


Fig. 50: 1038-0101 PCB Front

continues on next page

Table 21 – continued from previous page



303 Section 11

304 Bill of materials

305 11.1 1038A LED Display Stamp

306 The parts required to assemble a 1038A are listed in Table 22.

Table 22: 1038A parts

Reference Designation	Qty	Description	Manufacturer	Manufacturer Part Number	Supplier	Cost
1038-0101	1	Stamp PCB	JLCPCB	Y342-2154951A	JLCPCB	\$0.61 CAD
D1	1	Green LED Indication - Discrete 2V 0805 (2012 Metric)	Lumex Opto Components Inc.	SML-LXT0805GW-TR	Digikey	\$0.57 CAD
DS1	1	Four digit white LED seven-segment display	Wuxi ARK Tech Elec	SR720561W	LCSC	\$1.85
J1	1	Connector Header Through Hole 2 position 0.100" (2.54mm)	Molex	0022284020	Digikey	\$0.17 CAD
J2	1	8 Point solderless breadboard	Cixi Zhongyi Electronics Factory	ZY24	Zhongyi	\$1.01 CAD
J3	1	16 Point solderless breadboard	Cixi Zhongyi Electronics Factory	ZY28	Zhongyi	\$1.27 CAD
R1 - R4	4	10K Ohms ±1% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric)	Stackpole Electronics Inc	RMCF0603FT10K0	Digikey	\$0.64 CAD
R5 - R12	8	649 Ohms ±1% 0.1W, 1/10W Chip Resistor 0603 (1608 Metric)	Stackpole Electronics Inc	RMCF0603FT649R	Digikey	\$1.28 CAD
Q1 - Q4	4	Bipolar (BJT) Transistor NPN 40V 600mA SOT-23	Nexperia USA Inc.	MMBT2222A	Digikey	\$0.88 CAD
MP1 - MP8	8	Screw - M3 15mm White Nylon Phillips Socket Flat Head	Order By Description			\$0.66 CAD
MP9 - MP12	4	Standoff - M3 11mm+6 Black Nylon	Order By Description			\$0.30 CAD
MP13 - MP16	4	Nut - M3 Black Nylon	Order By Description			\$0.35 CAD
SK1	1	QC Sticker	Order by Description			\$0.0094 CAD
Total						\$9.60 CAD

307 11.2 1038A Packaging

308 The parts required to package a 1038A are listed in [Table 23](#).

Table 23: 1038A packing parts

Reference Designation	Qty	Description	Manufacturer	Manufacturer Part Number	Supplier	Cost
N/A	1	Static Shielding Bag 4" X 4" Ziplock	SCS	30044	Digikey	\$0.22 CAD
N/A	1	Static Shielding Bag 1.5" X 2.8" Ziplock	Order by Description			\$0.06 CAD
N/A	1	CORREC-PAK SHIPPER 4 X 4 X 2" ID	Conductive Containers, Inc.	3631	Digikey	\$7.99 CAD
1038-7001	2	1038A ESD Sticker	Jukebox Print			\$4.00 CAD
Total						\$12.27 CAD

309 **Section 12**

310 **Reduction of Hazardous Materials**

311 Compliance declarations, in BOM order.

312 **12.1 MG Chemicals 4900**

Table 24: MG Chemicals 4900 RoHS Compliance

Declaration for MG Chemicals 4900 -
<https://www.mgchemicals.com/downloads/msds/01%20English%20Can-USA%20SDS/sds-4900-4917.pdf>



ISO 9001:2015 Quality Management System
 SAI Global File #004008
 Burlington, Ontario, Canada

SAC305 NO CLEAN SOLDER WIRE

4900-4917

California Proposition 65 (Chemicals known to cause cancer or reproductive toxicity, USA)

This product does not contain any of the listed substances.

Europe

RoHS (Restriction of Hazardous Substances Directive)

This product does not contain any lead, cadmium, mercury, hexavalent chromium, PBB's, PBDE's, DEHP, BBP, DBP, or DIBP and complies with European RoHS regulations.

WEEE (Waste Electrical and Electronic Equipment Directive)

This product is not a piece of electrical or electronics equipment, and is therefore not governed by this regulation.

Section 16: Other Information

SDS Prepared by MG Chemical's Regulatory Department

Date of Review 06 March 2020

Supersedes 09 July 2019

Reason for Changes: Update to the emergency phone number information.

Reference

- 1) ACGIH 2017 TLVs and BEIs: Based on the documentation of the threshold limit values for chemical substances and physical agents & biological exposure indices, American Conference of Governmental of Industrial Hygienist Cincinnati, OH (2017).
- 2) All toxicological data were checked against the RTECS (Registry of Toxic Effects of Chemical Substances®)

Section continued on the next page

Page **12 of 13**

Date of Revision: 06 March 2020 / Ver. 3.01

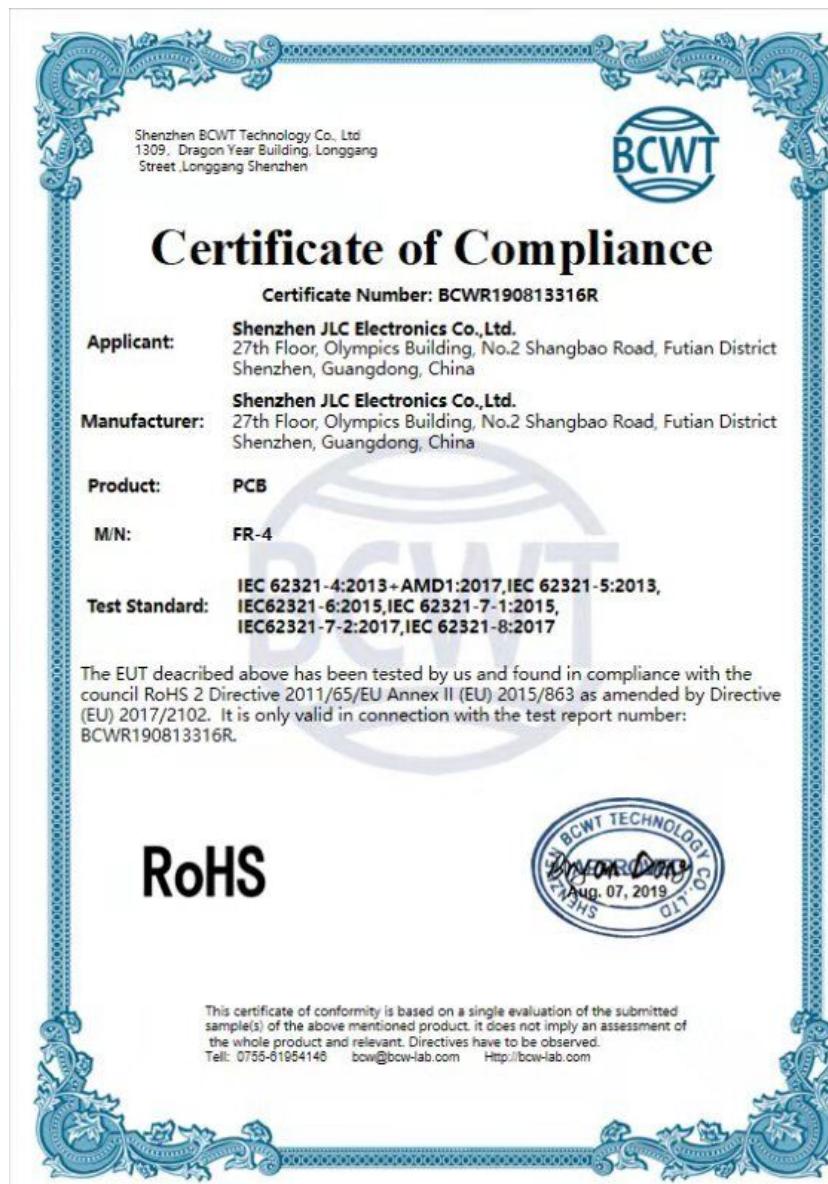
313 12.2 JLC lead-free PCB

Table 25: JLC PCB RoHS Compliance

Declaration for JLCPBCB lead-free PCBs - <https://s3.amazonaws.com/helpscout.net/docs/assets/59f1de7804286313cffbb22c/images/5d4d09562c7d3a036965d6a3/ROHS-Certificate-of-Compliance.jpg>

ROHS-Certificate-of-Compliance.jpg 566x800 pixels

2022-08-16, 23:45



<https://s3.amazonaws.com/helpscout.net/docs/assets/59f1de7804286313cffbb22c/images/5d4d09562c7d3a036965d6a3/ROHS-Certificate-of-Compliance.jpg>

Page 1 of 1

314 12.3 Lumex SML-LXT0805GW-TR

Table 26: Lumex SML-LXT0805GW-TR Compliance

Declaration for Lumex SML-LXT0805GW-TR - <https://www.lumex.com/attachment/RoHS%203%20REACH%20223%20TSCA%20POPs%20CoC.pdf>



ITW Electronic Component Solutions
 Carol Stream, IL 60188
 425 N. Gary Avenue
 www.itwecs.com

Date : 2022/5/6

Declaration of Conformity to EU RoHS & TSCA

LUMEX parts are in compliance with Directive 2011/65/EU of the European Parliament and Directive 2015/863/EU of the Council of 4 June 2015 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (also known as "RoHS Recast").

LUMEX parts are also in compliance with China RoHS & US TSCA(*) & POPs(**).

RoHS	
Substance	Maximum Limit (ppm)
Lead (Pb)	1000
Cadmium (Cd)	100
Mercury (Hg)	1000
Hexavalent Chromium (Cr6+)	1000
Poly Brominated Biphenyls (PBB)	1000
Poly Brominated Diphenyl ethers (PBDE)	1000
Bis(2-Ethylhexyl) phthalate (DEHP)	1000
Benzyl butyl phthalate (BBP)	1000
Dibutyl phthalate (DBP)	1000
Diisobutyl phthalate (DIBP)	1000

Some Product meet RoHS exemptions, list as Appendix I.

TSCA		
Substance	CAS No.	EC No.
Phenol, isopropylated phosphate (PIP 3:1)	68937-41-7	273-066-3
Decabromodiphenylether (DecaBDE)	1163-19-5	214-604-9
2,4,6-Tris(tert-butyl)phenol (2,4,6-TTBP)	732-26-3	211-989-5
Hexachlorobutadiene (HCBD)	87-68-3	201-765-5
Pentachlorothiophenol (PCTP)	133-49-3	205-107-8

315 12.4 ARKLED SR720561W

Table 27: ARKLED SR720561W RoHS Compliance

Declaration for ARKLED SR720561W -
https://datasheet.lcsc.com/lcsc/2203101903_ARKLED-Wuxi-ARK-Tech-Elec-SR720561W-32_C2980919.pdf

型 号 Type :
SR720561W



Page1 / 4

■ 产品特征 FEATURES:

- 高可靠性和高稳定性
High intensity and reliability
- 高品质、和低功耗、低成本
High quality, Low power requirement and low cost
- IC 兼容、易装配
IC compatible , Easy assembly
- 符合 RoHS 指令要求
Meet RoHS EU Directive
- 静电承受能力 (HBM) 1000V
ESD(HBM) 1000V

■ 产品描述 DESCRIPTION:

- 0.56 英寸四位数码管
0.56 Inch Four Digits Display
- 极性共阴
Common Cathode
- 黑面，黄胶
Black face, yellow segment
- 发光颜色
Lighting Color:
 - 1、白色 WHITE
 - 2、
 - 3、
 - 4、
 - 5、
- 晶片材质
Chips Materials
 - 1、InGaN
 - 2、
 - 3、
 - 4、
 - 5、

316 **12.5 Molex 0022284020**

Table 28: Molex 0022284020 RoHS Compliance

Declaration for Molex 0022284020 - https://www.molex.com/datasheets/rohspdf/0022284020_rohs.pdf**RoHS Certificate of Compliance**

06/29/2022

Molex is committed to managing the use of chemical substances in accordance with governmental regulations, industry standards, and customer-specific requirements in order to protect the environment. For each part listed, this document provides:

- EU RoHS Compliance Status.** EU RoHS status is declared per Directive 2011/65/EU and its subsequent amendments, including the Directive EU 2015/863 which additionally prohibited four phthalates. Homogeneous materials of parts that are compliant to this legislation have less than 0.1% by weight each of lead, mercury, hexavalent chromium, PBB, PBDE, DBP, BBP, DIBP, DEHP, and 0.01% by weight of cadmium. In situations where an exemption applies, the preceding limits, corresponding to the exempted substance(s), may be higher.

Molex's sole liability for incorrectly certifying a product shall be either replacement of the Molex product or, alternatively and in the sole discretion of Molex, return of the purchase price paid for the relevant Molex product.

For additional information regarding Molex's environmental initiatives and further explanation of this information, please visit www.molex.com

Haim Eliyahu
Director, Global Product Stewardship

Table A

Molex Part Number	Part Description	RoHS Compliance Status
0022284020	KK 254 Breakaway Header, Vertical, 2 Circuits, Tin (Sn) Plating, Mating Pin Length 6.09mm	Compliant

317 **12.6 Cixi ZY24**

Table 29: Cixi ZY24 Compliance

Declaration for Cixi ZY24 -
<http://27696974.s21i.faiusr.com/2/ABUIABACGAAghLXJiwYogKav1QYwoAY46wg.jpg>

Certificate of Compliance

Certificate Number: BSTDG190612860702CC

Applicant	: CIXI ZHONGYI ELECTRONICS FACTORY Yuxiang Road, Xiaolin Town 315321 Cixi City Zhejiang Province China
Manufacturer	: CIXI ZHONGYI ELECTRONICS FACTORY Yuxiang Road, Xiaolin Town 315321 Cixi City Zhejiang Province China
Product Name	: BREAD BOARD
Test Standard	: IEC 62321-4:2013+AMD1:2017, IEC 62321-5:2013, IEC 62321-6:2015, IEC 62321-7-1:2015, IEC 62321-7-2:2017, IEC 62321-8:2017
As shown in the Test Report No.	: BSTDG190612860702CR

The EUT described above has been tested by us and found in compliance with the council RoHS 2 Directive 2011/65/EU Annex II (EU) 2015/863 as last amended by Directive (EU) 2017/2102. This certificate is only valid in conjunction with the test report.

RoHS

Tony Qian
Approved Signatory
Jun.10, 2019

Dongguan BST Testing Co., Ltd
Add: A1201-1204 Xinsanqi of Dongbao Road, Dongcheng District, Dongguan, Guangdong, China
Certificate Search: <http://www bst-lab com>, Tel: 400-8829628, 800-9990305, E-mail: christina@bst-lab com

318 **12.7 Cixi ZY28**

Table 30: Cixi ZY28 Compliance

Declaration for Cixi ZY28 -
<http://27696974.s21i.faiusr.com/2/ABUIABACGAAghLXJiwYogKav1QYwoAY46wg.jpg>



BST | A RELIABLE TESTING FOR TRUST
 GLOBAL TESTING AND CERTIFICATION PRECISION SERVICE CLOUD FACTORY

Certificate of Compliance

Certificate Number: BSTDG190612860702CC

Applicant	: CIXI ZHONGYI ELECTRONICS FACTORY Yuxiang Road, Xiaolin Town 315321 Cixi City Zhejiang Province China
Manufacturer	: CIXI ZHONGYI ELECTRONICS FACTORY Yuxiang Road, Xiaolin Town 315321 Cixi City Zhejiang Province China
Product Name	: BREAD BOARD
Test Standard	: IEC 62321-4:2013+AMD1:2017, IEC 62321-5:2013, IEC 62321-6:2015, IEC 62321-7-1:2015, IEC 62321-7-2:2017, IEC 62321-8:2017
As shown in the Test Report No.	: BSTDG190612860702CR

The EUT described above has been tested by us and found in compliance with the council RoHS 2 Directive 2011/65/EU Annex II (EU) 2015/863 as last amended by Directive (EU) 2017/2102. This certificate is only valid in conjunction with the test report.



RoHS



Tony Qian
Approved Signatory
Jun.10, 2019

Dongguan BST Testing Co., Ltd
 Add: A1201-1204 Xinsanqi of Dongbao Road, Dongcheng District, Dongguan, Guangdong, China
 Certificate Search: <http://www bst-lab.com>, Tel: 400-8829628, 800-9990305, E-mail: christina@bst-lab.com

319 12.8 Stackpole RMCF0603FT10K0

Table 31: Stackpole RMCF0603FT10K0 RoHS Compliance

Declaration for Stackpole RMCF0603FT10K0 -
https://www.seiselect.com/catalog/SEI-RoHS_Compliance_Status.pdf

RoHS Compliance Status

Stackpole Electronics, Inc.
 Resistive Product Solutions

Resistors						
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)
NSP	Ceramic Housed - Consumer Grade Leaded Resistor <i>DISCONTINUED (May 3, 2013)</i>	Axial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NSZ	Ceramic Housed Wirewound Resistor with Specialty Leads	Radial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NVM	Ceramic Housed Vertical Mount Wirewound Resistor (Standard WW)	Radial	YES	100% Matte Sn	Always	Always
NWW	General Purpose and Precision Leaded Wirewound Resistor - Conformal Coated - Non-Inductive	Axial	YES	100% Matte Sn	Jan-06	06/01
PCB	Ceramic Housed Leaded Wirewound Resistor - PC Mount <i>DISCONTINUED (July 1, 2014)</i>	Radial	YES	100% Matte Sn	Always	Always
RACF	Thick Film Surface Mount Chip Resistor Array Concave Terminations <i>DISCONTINUED (Nov. 15, 2019)</i>	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-04	04/01
RAF	Thick Film Surface Mount Chip Resistor Array Flat Terminations	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jul-04	04/27
RAVF	Thick Film Surface Mount Chip Resistor Array Convex Terminations	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-04 (Japan) Jul-04 (Taiwan)	04/01 04/27
RAVS	Convex Anti-Sulfur Chip Resistor Array	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RC	Carbon Composition Leaded Resistor	Axial	YES	100% Matte Sn	Jan-86	86/01
RGC	Semi-Precision Thick Film Surface Mount Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jul-04	04/27
RHC	High Power Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jul-04	04/27
RMCA	Automotive Grade Thick Film Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMCF	General Purpose Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-04 (Japan) Jan-05 (Taiwan, China)	04/01 05/01
RMCG	Gold Barrier Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-06	06/01
RMCP	General Purpose High Power Thick Film Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMCS	Sulfur Resistant Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMCW	Wide Termination Thick Film Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMEF	General Purpose Thick Film Surface Mount Chip Resistor 100% Lead Free	SMD	YES	100% Mtte Sn over Ni	Always	Always
RNCF	Precision Thin Film Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCH	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCP	High Power Anti-Sulfur Thin Film Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCS	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCW	Thin Film Wire-Bondable Chip Resistor - <i>DISCONTINUED (Jan. 17, 2018)</i>	SMD	YES	Gold Plating	Always	Always
RNF	General Purpose Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNMF	General Purpose Mini Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNS	Ultra-Miniature Metal Film Resistor	Axial	YES	100% Matte Sn	Always	Always

Note (1): RoHS Compliant by means of exemption 7c-l.

Rev Date: 3/1/2022

3

www.seiselect.com
marketing@seiselect.com

320 12.9 Stackpole RMCF0603FT649R

Table 32: Stackpole RMCF0603FT649R RoHS Compliance

Declaration for Stackpole RMCF0603FT649R -
https://www.seiselect.com/catalog/SEI-RoHS_Compliance_Status.pdf

RoHS Compliance Status

Stackpole Electronics, Inc.
 Resistive Product Solutions

Resistors						
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)
NSP	Ceramic Housed - Consumer Grade Leaded Resistor <i>DISCONTINUED (May 3, 2013)</i>	Axial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NSZ	Ceramic Housed Wirewound Resistor with Specialty Leads	Radial	YES	99.3/0.7 Sn/Cu	Jan-04	04/01
NVM	Ceramic Housed Vertical Mount Wirewound Resistor (Standard WW)	Radial	YES	100% Matte Sn	Always	Always
NWW	General Purpose and Precision Leaded Wirewound Resistor - Conformal Coated - Non-Inductive	Axial	YES	100% Matte Sn	Jan-06	06/01
PCB	Ceramic Housed Leaded Wirewound Resistor - PC Mount <i>DISCONTINUED (July 1, 2014)</i>	Radial	YES	100% Matte Sn	Always	Always
RACF	Thick Film Surface Mount Chip Resistor Array Concave Terminations <i>DISCONTINUED (Nov. 15, 2019)</i>	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-04	04/01
RAF	Thick Film Surface Mount Chip Resistor Array Flat Terminations	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jul-04	04/27
RAVF	Thick Film Surface Mount Chip Resistor Array Convex Terminations	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-04 (Japan) Jul-04 (Taiwan)	04/01 04/27
RAVS	Convex Anti-Sulfur Chip Resistor Array	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RC	Carbon Composition Leaded Resistor	Axial	YES	100% Matte Sn	Jan-86	86/01
RGC	Semi-Precision Thick Film Surface Mount Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jul-04	04/27
RHC	High Power Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jul-04	04/27
RMCA	Automotive Grade Thick Film Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMCF	General Purpose Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-04 (Japan) Jan-05 (Taiwan, China)	04/01 05/01
RMCG	Gold Barrier Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Jan-06	06/01
RMCP	General Purpose High Power Thick Film Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMCS	Sulfur Resistant Thick Film Surface Mount Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMCW	Wide Termination Thick Film Chip Resistor	SMD	YES ⁽¹⁾	100% Matte Sn over Ni	Always	Always
RMEF	General Purpose Thick Film Surface Mount Chip Resistor 100% Lead Free	SMD	YES	100% Mtte Sn over Ni	Always	Always
RNCF	Precision Thin Film Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCH	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCP	High Power Anti-Sulfur Thin Film Chip Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always
RNCS	Anti-Corrosive Tantalum Nitride Replacement Surface Mount Chip Resistor	SMD	YES	100% Matte Sn over Ni	May-04	04/18
RNCW	Thin Film Wire-Bondable Chip Resistor - <i>DISCONTINUED (Jan. 17, 2018)</i>	SMD	YES	Gold Plating	Always	Always
RNF	General Purpose Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNMF	General Purpose Mini Metal Film Leaded Resistor	Axial	YES	99.3/0.7 Sn/Cu 100% Matte Sn	Apr-05 (Japan) Jan-04 (Taiwan, China)	05/14 04/01
RNS	Ultra-Miniature Metal Film Resistor	Axial	YES	100% Matte Sn	Always	Always

Note (1): RoHS Compliant by means of exemption 7c-l.

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321 12.10 Nexperia MMBT2222A

Table 33: Nexperia MMBT2222A RoHS Compliance

Declaration for Nexperia MMBT2222A - <https://www.nexperia.com/dam/jcr:96c06925-615d-4095-b779-3718c9f9cdde/Nexperia%20-%20Statement%20on%20RoHS.pdf>



July 2022

CERTIFICATE OF COMPLIANCE - RoHS Declaration -

Nexperia B.V. declares that its semiconductor products (including homogeneous sub-components, pins, casing, and internal parts) are designed to be:

RoHS compliant by meeting the requirements defined under Directive 2011/65/EU of 2011-07-21, amended by Directive (EU) 2015/863 of 2015-03-31, on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE):

RoHS Restricted Substance	Allowable Limit
Cadmium (Cd)	100 ppm (0.01 weight %)
Mercury (Hg)	1000 ppm (0.1 weight %)
Hexavalent chromium (Cr ⁶⁺)	1000 ppm (0.1 weight %)
Lead (Pb)	1000 ppm (0.1 weight %)
Polybrominated biphenyls (PBBs)	1000 ppm (0.1 weight %)
Polybrominated diphenyl ethers (PBDEs)*	1000 ppm (0.1 weight %)
Bis(2-ethylhexyl) phthalate (DEHP)	1000 ppm (0.1 weight %)
Butyl benzyl phthalate (BBP)	1000 ppm (0.1 weight %)
Dibutyl phthalate (DBP)	1000 ppm (0.1 weight %)
Diisobutyl phthalate (DIBP)	1000 ppm (0.1 weight %)

* Including decabromodiphenylether (decaBDE).

All Nexperia devices are RoHS compliant. Nexperia devices contain no more than 0.1 % lead (Pb) by weight per homogeneous material or may contain lead (Pb) in applications allowed by the RoHS Directive. Nexperia may apply any of the following RoHS exemptions to RoHS compliant Nexperia devices:

RoHS Exemption	RoHS Exemption Description
7(a)	Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead)
7(c)-I	Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound

Nexperia devices can be recognized by the "RoHS compliant" logo on the box label. In addition, products that do not make use of any exemption on the use of lead can be recognized by the "Lead-free" logo.

To facilitate customer requirements and to verify Nexperia product compliance, Nexperia material content information is available here:
<https://www.nexperia.com/quality/download-multiple-product-compositions.html>

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322 **12.11 M3 5mm Nylon Screw**

Table 34: M3 5mm Nylon Screw RoHS Compliance



323 **12.12 M3 11mm Nylon Standoff**

Table 35: M3 11mm Nylon Standoff RoHS Compliance



324 12.13 M3 Nylon Bolt

Table 36: M3 Nylon Bolt RoHS Compliance

